

Armstrong A-661 Epoxy Resin Adhesive

July 2015

PRODUCT DESCRIPTION

Armstrong A-661 epoxy adhesive is a two-component, room temperature curing adhesive which produces bonds with excellent shear strength, even after long-term exposure at temperatures up to 400°F. It is a smoothly brushable, non-sag, easy to apply paste that will cure to handling strength over night at room temperature, or may be speed cured at 165°F, or higher if desired.

APPLICATIONS

Store below 25°C out of sunlight and in original unopened containers. Refer to packaging specific quote for shelf life information.

Instructions

- The surfaces to be bonded should be clean and dry (for critical applications refer to our suggested surface preparation procedures - Bulletin No. 964)
- 2. Thoroughly mix the A-661 Part B with the A-661 part A in a clean discardable container using correct mix ratio. Avoid the introduction of excess air.
- Apply the adhesive to surfaces to be bonded (preferably both surfaces) and press together. Light clamping may be used to keep parts in position during curing.
- 4. Cure as desired.

TYPICAL PHYSICAL PROPERTIES

	Part A	Part B
Viscosity @77°F (poise)		10.800
Specific Gravity	1.42	1.00
Color	Grey	Dark Amber

Mixed Systems (Part A/Part B)

Mix Ratio (by weight) 4:1
Mix Viscosity @ 77°F Thixotropic
Working Life @77°F (100 grams) Approx 3 Hrs

TYPICAL PHYSICAL PROPERTIES OF CURED SYSTEM*

Tensile Shear (psi) (al/al)

@ 77°F	3300
@ 180°F	3460
@300°F	760
@400°F	430
Bond Strength (psi)	5300
Tensile Strength (psi)	2800
Elongation, maximum (%)	2.0%
*Cured 10' @ 300°F	

Storage

Store below 25°C out of sunlight and in original unopened containers. Refer to packaging specific quote for shelf life information.

Data Ranges

The data contained herein may be reported as a typical value and/or range. Values are based on actual test data and are verified on a periodic basis.

Note

The product for which the data provided herein are furnished for informational purposes only and are believed to be accurate and reliable. Nevertheless, Henkel Corporation cannot and will not assume responsibility for the results obtained by others over whose production methods we have no control. Thus, it is the user's responsibility to determine the suitability of this product for the user's purpose of any production methods mentioned herein and to adopt such precautions as may be advisable for the protection of property and of persons against any hazards that may be involved in the handling, storage, disposal and use thereof. In light of the foregoing, HENKEL CORPORATION SPECIFICALLY DISCLAIMS ANY AND ALL WARRANTIES EXPRESSED OR IMPLIED. INCLUDING WARRANTIES OF MERCHANTABILITY, FITNESS FOR A PARTICULAR PURPOSE AND FREE FROM CLAIMS OF THIRD PARTY PATENT INFRINGEMENT, ARISING FROM THE SALE, POSSESSION, HANDLING, STORAGE, **DISPOSAL, TRANSPORTATION OR USE OF THIS** PRODUCT. HENKEL CORPORATION SPECIFICALLY DISCLAIMS ANY LIABILITY FOR CONSEQUENTIAL OR INCIDENTAL DAMAGES OF ANY KIND, INCLUDING LOST **PROFITS.** Neither the product, nor the data or discussion herein of various processes for which, are to be interpreted as an express or implied license under any Henkel Corporation patents. Henkel Corporation recommends that any and all proposed commercial application(s) using this product be evaluated for reproducibility in the exact manner and on the production equipment with which it is intended to be used before repetitive commercial production use, using this data as a guide. This product may be covered by one or more United States or foreign patents or patent applications of Henkel Corporation, or under which Henkel Corporation is licensed.

